

# 32-Macrocell MAX® EPL

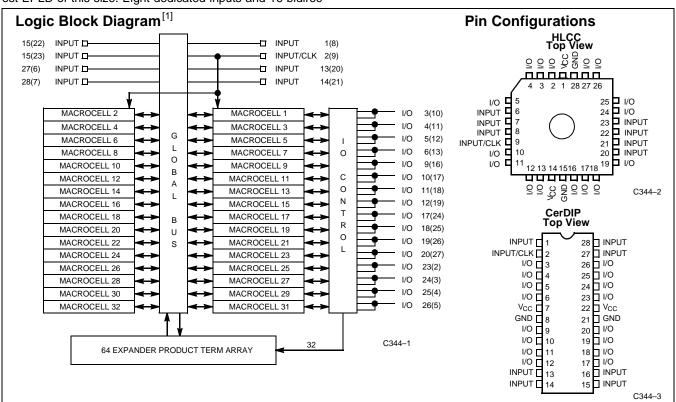
#### **Features**

- · High-performance, high-density replacement for TTL, 74HC, and custom logic
- 32 macrocells, 64 expander product terms in one LAB
- 8 dedicated inputs, 16 I/O pins
- 0.8-micron double-metal CMOS EPROM technology
- 28-pin, 300-mil DIP, cerDIP or 28-pin HLCC, PLCC package

### **Functional Description**

Available in a 28-pin, 300-mil DIP or windowed J-leaded ceramic chip carrier (HLCC), the CY7C344 represents the densest EPLD of this size. Eight dedicated inputs and 16 bidirectional I/O pins communicate to one logic array block. In the CY7C344 LAB there are 32 macrocells and 64 expander product terms. When an I/O macrocell is used as an input, two expanders are used to create an input path. Even if all of the I/O pins are driven by macrocell registers, there are still 16 "buried" registers available. All inputs, macrocells, and I/O pins are interconnected within the LAB.

The speed and density of the CY7C344 makes it a natural for all types of applications. With just this one device, the designer can implement complex state machines, registered logic, and combinatorial "glue" logic, without using multiple chips. This architectural flexibility allows the CY7C344 to replace multichip TTL solutions, whether they are synchronous, asynchronous, combinatorial, or all three.



#### Salaction Guida

		7C344-15	7C344-20	7C344-25
Maximum Access Time (ns)		15	20	25
(mΔ)	Commercial	200	200	200
	Military		220	220
	Industrial	220	220	220
Maximum Standby Current (mA)	Commercial	150	150	150
	Military		170	170
	Industrial	170	170	170

#### Note:

Numbers in () refer to J-leaded packages.



# **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature .....-65°C to +150°C Ambient Temperature with Power Applied......0°C to +70°C Maximum Junction Temperature (Under Bias)......150°C Supply Voltage to Ground Potential......-2.0V to +7.0V Maximum Power Dissipation......1500 mW DC V<sub>CC</sub> or GND Current......500 mA

Static Discharge Voltage (per MIL-STD-883, Method 3015) .	>2001V
DC Output Current, per Pin	25 mA to +25 mA
DC Input Voltage <sup>[2]</sup>	3.0V to +7.0V
DC Program Voltage	+13.0V

### **Operating Range**

Range	Ambient Temperature	v <sub>cc</sub>
Commercial	0°C to +70°C	5V ±5%
Industrial	-40°C to +85°C	5V ±10%
Military	-55°C to +125°C (Case)	5V ±10%

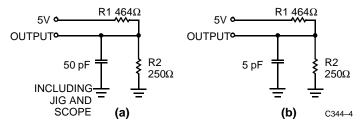
# Electrical Characteristics Over the Operating Range<sup>[3]</sup>

Parameter	Description	Test Condition	ons	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> = Min., I <sub>OH</sub> = -4.0 mA		2.4		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8 mA			0.45	V
V <sub>IH</sub>	Input HIGH Level			2.2	V <sub>CC</sub> +0.3	V
V <sub>IL</sub>	Input LOW Level			-0.3	0.8	V
I <sub>IX</sub>	Input Current	$GND \le V_{IN} \le V_{CC}$		-10	+10	μΑ
l <sub>OZ</sub>	Output Leakage Current	$V_O = V_{CC}$ or GND		-40	+40	μΑ
Ios	Output Short Circuit Current	$V_{CC} = Max., V_{OUT} = 0.5V^{[4, 5]}$		-30	-90	mA
I <sub>CC1</sub>	Power Supply	V <sub>I</sub> = V <sub>CC</sub> or GND (No Load)	Commercial		150	mA
	Current (Standby)		Military/Industrial		170	mA
I <sub>CC2</sub>	Power Supply Current	$V_I = V_{CC}$ or GND (No Load) f = 1.0 MHz <sup>[4,6]</sup>	Commercial		200	mA
		$f = 1.0 \text{ MHz}^{[4,0]}$	Military/Industrial		220	mA
t <sub>R</sub>	Recommended Input Rise Time		•		100	ns
t <sub>F</sub>	Recommended Input Fall Time				100	ns

### Capacitance

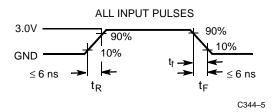
Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 2V, f = 1.0 MHz	10	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 2.0V, f = 1.0 MHz	10	pF

### AC Test Loads and Waveforms<sup>[7]</sup>



 $163\Omega$ 

THÉVENIN EQUIVALENT (commercial/military)



# Notes:

Equivalent to:

Minimum DC input is -0.3V. During transitions, the inputs may undershoot to -2.0V for periods less than 20 ns. Typical values are for  $T_A = 25$ °C and  $V_{CC} = 5$ V. Guaranteed by design but not 100% tested.

**-•** 1.75∨

**OUTPUT** 

Not more than one output should be tested at a time. Duration of the short circuit should not be more than one second. V<sub>OUT</sub> = 0.5V has been chosen to avoid test problems caused by tester ground degradation.

C344-6

Measured with device programmed as a 16-bit counter.

Part (a) in AC Test Load and Waveforms is used for all parameters except t<sub>ER</sub> and t<sub>XZ</sub>, which is used for part (b) in AC Test Load and Waveforms. All external timing parameters are measured referenced to external pins of the device.



# **Timing Delays**

Timing delays within the CY7C344 may be easily determined using *Warp*<sup>™</sup>, *Warp* Professional<sup>™</sup>, or *Warp* Enterprise<sup>™</sup> software. The CY7C344 has fixed internal delays, allowing the user to determine the worst case timing delays for any design.

### **Design Recommendations**

Operation of the devices described herein with conditions above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this data sheet is not implied. Exposure to absolute maximum ratings conditions for extended periods of time may affect device reliability. The CY7C344 contains circuitry to protect device pins from high-static voltages or electric fields; however, normal precautions should be taken to avoid applying any voltage higher than maximum rated voltages.

For proper operation, input and output pins must be constrained to the range GND  $\leq$  (V<sub>IN</sub> or V<sub>OUT</sub>)  $\leq$  V<sub>CC</sub>. Unused inputs must always be tied to an appropriate logic level (either V<sub>CC</sub> or GND). Each set of V<sub>CC</sub> and GND pins must be connected together directly at the device. Power supply decoupling capacitors of at least 0.2  $\mu\text{F}$  must be connected between V<sub>CC</sub> and GND. For the most effective decoupling, each V<sub>CC</sub> pin should be separately decoupled.

# **Timing Considerations**

Unless otherwise stated, propagation delays do not include expanders. When using expanders, add the maximum expander delay  $t_{\text{EXP}}$  to the overall delay.

When calculating synchronous frequencies, use  $t_{S1}$  if all inputs are on the input pins.  $t_{S2}$  should be used if data is applied at an I/O pin. If  $t_{S2}$  is greater than  $t_{CO1}$ ,  $1/t_{S2}$  becomes the limiting frequency in the data-path mode unless  $1/(t_{WH} + t_{WI})$  is less than  $1/t_{S2}$ .

When expander logic is used in the data path, add the appropriate maximum expander delay,  $t_{\rm EXP}$  to  $t_{\rm S1}$ . Determine which of  $1/(t_{\rm WH}+t_{\rm WL})$ ,  $1/t_{\rm CO1}$ , or  $1/(t_{\rm EXP}+t_{\rm S1})$  is the lowest frequency. The lowest of these frequencies is the maximum data-path frequency for the synchronous configuration.

When calculating external asynchronous frequencies, use  $t_{AS1}$  if all inputs are on dedicated input pins. If any data is applied to an I/O pin,  $t_{AS2}$  must be used as the required set-up time. If  $(t_{AS2} + t_{AH})$  is greater than  $t_{ACO1}$ ,  $1/(t_{AS2} + t_{AH})$  becomes the limiting frequency in the data-path mode unless  $1/(t_{AWH} + t_{AWL})$  is less than  $1/(t_{AS2} + t_{AH})$ .

When expander logic is used in the data path, add the appropriate maximum expander delay,  $t_{\rm EXP}$  to  $t_{\rm AS1}$ . Determine which of  $1/(t_{\rm AWH}+t_{\rm AWL})$ ,  $1/t_{\rm ACO1}$ , or  $1/(t_{\rm EXP}+t_{\rm AS1})$  is the lowest frequency. The lowest of these frequencies is the maximum data-path frequency for the asynchronous configuration.

The parameter  $t_{OH}$  indicates the system compatibility of this device when driving other synchronous logic with positive input hold times, which is controlled by the same synchronous clock. If  $t_{OH}$  is greater than the minimum required input hold time of the subsequent synchronous logic, then the devices are guaranteed to function properly with a common synchronous clock under worst-case environmental and supply voltage conditions.

The parameter  $t_{AOH}$  indicates the system compatibility of this device when driving subsequent registered logic with a positive hold time and using the same clock as the CY7C344. In general, if  $t_{AOH}$  is greater than the minimum required input hold time of the subsequent logic (synchronous or asynchronous), then the devices are guaranteed to function properly under worst-case environmental and supply voltage conditions, provided the clock signal source is the same. This also applies if expander logic is used in the clock signal path of the driving device, but not for the driven device. This is due to the expander logic in the second device's clock signal path adding an additional delay ( $t_{EXP}$ ), causing the output data from the preceding device to change prior to the arrival of the clock signal at the following device's register.

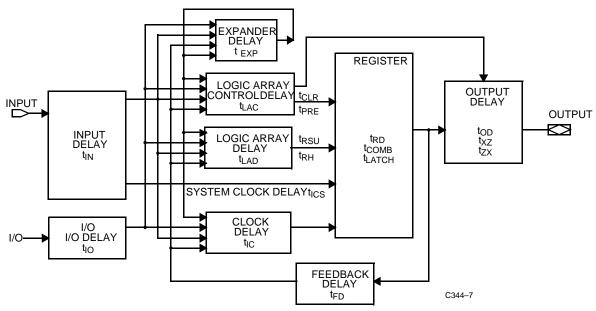


Figure 1. CY7C344 Timing Model.

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# External Synchronous Switching Characteristics<sup>[7]</sup> Over Operating Range

			7C3	44-15	7C3	44-20	7C3	44-25	
Parameter	Description		Min.	Max.	Min.	Max.	Min.	Max.	Unit
t <sub>PD1</sub>	Dedicated Input to Combinatorial Output Delay <sup>[8]</sup>	Com'l/Ind		15		20		25	ns
		Mil		15		20		25	]
t <sub>PD2</sub>	I/O Input to Combinatorial Output Delay <sup>[9]</sup>	Com'l/Ind		15		20		25	ns
		Mil		15		20		25	
t <sub>PD3</sub>	Dedicated Input to Combinatorial Output Delay	Com'l/Ind		30		30		40	ns
	with Expander Delay <sup>[10]</sup>	Mil		30		30		40	1
t <sub>PD4</sub>	I/O Input to Combinatorial Output Delay with	Com'l/Ind		30		30		40	ns
	Expander Delay <sup>[4, 11]</sup>			30		30		40	1
t <sub>EA</sub>	Input to Output Enable Delay[4]	Com'l/Ind		20		20		25	ns
		Mil		20		20		25	1
t <sub>ER</sub>	Input to Output Disable Delay <sup>[4]</sup>	Com'l/Ind		20		20		25	ns
		Mil		20		20		25	
t <sub>CO1</sub>	Synchronous Clock Input to Output Delay	Com'l/Ind		10		12		15	ns
		Mil		10		12		15	
t <sub>CO2</sub>	Synchronous Clock to Local Feedback to Com-	Com'l/Ind		20		22		29	ns
	binatorial Output <sup>[4, 12]</sup>	Mil		20		22		29	1
t <sub>S</sub>	Dedicated Input or Feedback Set-Up Time to	Com'l/Ind	10		12		15		ns
	Synchronous Clock Input	Mil	10		12		15		1
t <sub>H</sub>	Input Hold Time from Synchronous Clock Input <sup>[7]</sup>		0		0		0		ns
••	, , , , , , , , , , , , , , , , , , ,	Mil	0		0		0		
t <sub>WH</sub>	Synchronous Clock Input HIGH Time <sup>[4]</sup>	Com'l/Ind	6		7		8		ns
****	·	Mil	6		7		8		-
t <sub>WL</sub>	Synchronous Clock Input LOW Time <sup>[4]</sup>	Com'l/Ind	6		7		8		ns
VVL	, i	Mil	6		7		8		1
t <sub>RW</sub>	Asynchronous Clear Width <sup>[4]</sup>	Com'l/Ind	20		20		25		ns
IXVV		Mil	20		20		25		-
t <sub>RR</sub>	Asynchronous Clear Recovery Time <sup>[4]</sup>	Com'l/Ind	20		20		25		ns
IXIX		Mil	20		20		25		=
t <sub>RO</sub>	Asynchronous Clear to Registered Output Delay <sup>[4]</sup>	Com'l/Ind		15		20		25	ns
NO	Delay <sup>[4]</sup>	Mil		15		20		25	=
t <sub>PW</sub>	Asynchronous Preset Width <sup>[4]</sup>	Com'l /Ind	20		20		25		ns
1 44		Mil	20		20		25		-
t <sub>PR</sub>	Asynchronous Preset Recovery Time <sup>[4]</sup>	Com'l /Ind	20		20		25		ns
110		Mil	20		20		25		=
t <sub>PO</sub>	Asynchronous Preset to Registered Output			15		20		25	ns
, 0	Delay <sup>[4]</sup>	Com'l /Ind Mil		15		20		25	1
t <sub>CF</sub>	Synchronous Clock to Local Feedback Input <sup>[4, 13]</sup>	Com'l /Ind		4		4		7	ns
Ji		Mil		4		4		7	1
t <sub>P</sub>	External Synchronous Clock Period (1/f <sub>MAX3</sub> ) <sup>[4]</sup>	Com'I/Ind	13		14		16		ns
т'		Mil	13		14		16		1



# External Synchronous Switching Characteristics [7] Over Operating Range (continued)

			7C3	44-15	7C3	44-20	7C3	44-25	
Parameter	Description		Min.	Max.	Min.	Max.	Min.	Max.	Unit
f <sub>MAX1</sub>	External Maximum Frequency(1/(t <sub>CO1</sub> + t <sub>S</sub> )) <sup>[4, 14]</sup>	Com'l/Ind	50.0		41.6		33.3		MHz
		Mil	50.0		41.6		33.3		
f <sub>MAX2</sub>	Maximum Frequency with Internal Only Feedback (1/(t <sub>CF</sub> + t <sub>S</sub> )) <sup>[4, 15]</sup>	Com'l/Ind	71.4		62.5		45.4		MHz
	Feedback (1/(t <sub>CF</sub> + t <sub>S</sub> )) <sup>[4, 15]</sup>		71.4		62.5		45.4		
f <sub>MAX3</sub>	Data Path Maximum Frequency, least of 1/(t <sub>WL</sub> + t <sub>WH</sub> ), 1/(t <sub>S</sub> + t <sub>H</sub> ), or (1/t <sub>CO1</sub> ) <sup>[4, 16]</sup>	Com'l/Ind	83.3		71.4		62.5		MHz
	$1/(t_{WL} + t_{WH}), 1/(t_{S} + t_{H}), \text{ or } (1/t_{CO1})^{[4, 16]}$	Mil	83.3		71.4		62.5		
f <sub>MAX4</sub>	Maximum Register Toggle Frequency 1/(t <sub>WL</sub> + t <sub>WH</sub> ) <sup>[4, 17]</sup>	Com'l/Ind	83.3		71.4		62.5		MHz
	$1/(t_{WL} + t_{WH})^{[4, 17]}$	Mil	83.3		71.4		62.5		
t <sub>OH</sub>	Output Data Stable Time from Synchronous	Com'l/Ind	3		3		3		ns
	Clock Input <sup>[4, 18]</sup>		3		3		3		

#### Notes:

- This parameter is the delay from an input signal applied to a dedicated input pin to a combinatorial output on any output pin. This delay assumes no expander 8. terms are used to form the logic function.

  This parameter is the delay associated with an input signal applied to an I/O macrocell pin to any output. This delay assumes no expander terms are used to
- form the logic function.
- This parameter is the delay associated with an input signal applied to a dedicated input pin to combinatorial output on any output pin. This delay assumes expander terms are used to form the logic function and includes the worst-case expander logic delay for one pass through the expander logic. This parameter is tested periodically by sampling production material.
- This parameter is the delay associated with an input signal applied to an I/O macrocell pin to any output pin. This delay assumes expander terms are used to form the logic function and includes the worst-case expander logic delay for one pass through the expander logic. This parameter is tested periodically by sampling production material.
- This specification is a measure of the delay from synchronous register clock input to internal feedback of the register output signal to a combinatorial output for which the registered output signal is used as an input. This parameter assumes no expanders are used in the logic of the combinatorial output and the register is synchronously clocked. This parameter is tested periodically by sampling production material.

  This specification is a measure of the delay associated with the internal register feedback path. This delay plus the register set-up time, t<sub>S</sub>, is the minimum
- internal period for an internal state machine configuration. This parameter is tested periodically by sampling production material.

  This specification indicates the guaranteed maximum frequency at which a state machine configuration with external only feedback can operate.

  This specification indicates the guaranteed maximum frequency at which a state machine with internal-only feedback can operate. If register output states must also control external points, this frequency can still be observed as long as it is less than 1/t<sub>CO1</sub>. This specification assumes no expander logic is used. This
- parameter is tested periodically by sampling production material.

  This frequency indicates the maximum frequency at which the device may operate in data-path mode (dedicated input pin to output pin). This assumes that no expander logic is used.
- This specification indicates the guaranteed maximum frequency in synchronous mode, at which an individual output or buried register can be cycled by a clock signal applied to either a dedicated input pin or an I/O pin.

  This parameter indicates the minimum time after a synchronous register clock input that the previous register output data is maintained on the output pin.



# External Asynchronous Switching Characteristics Over Operating Range<sup>[7]</sup>

			7C3	44-15	7C3	44-20	7C3	44-25	
Parameter	Description		Min.	Max.	Min.	Max.	Min.	Max.	Unit
t <sub>ACO1</sub>	Asynchronous Clock Input to Output Delay	Com'l/Ind		15		20		25	ns
		Mil		15		20		25	
t <sub>ACO2</sub>	Asynchronous Clock Input to Local Feedback to Combinatorial Output <sup>[19]</sup>	Com'l/Ind		30		30		37	ns
	Combinatorial Output <sup>[19]</sup>	Mil		30		30		37	
t <sub>AS</sub>	Dedicated Input or Feedback Set-Up Time to	Com'l/Ind	7		9		12		ns
	Asynchronous Clock Input	Mil	7		9		12		
t <sub>AH</sub>	Input Hold Time from Asynchronous Clock Input	Com'l/Ind	7		9		12		ns
		Mil	7		9		12		
t <sub>AWH</sub>	Asynchronous Clock Input HIGH Time <sup>[4, 20]</sup>	Com'l/Ind	6		7		9		ns
			6		7		9		
t <sub>AWL</sub>	Asynchronous Clock Input LOW Time <sup>[4]</sup>	Com'l/Ind	7		9		11		ns
		Mil	7		9		11		
t <sub>ACF</sub> Async	Asynchronous Clock to Local Feedback Input <sup>[4, 21]</sup>	Com'l/Ind		18		18		21	ns
		Mil		18		18		21	
t <sub>AP</sub>	External Asynchronous Clock Period (1/f <sub>MAX4</sub> ) <sup>[4]</sup>	Com'l/Ind	13		16		20		ns
		Mil	13		16		20		
f <sub>MAXA1</sub>	External Maximum Frequency in Asynchronous Mode 1/(t <sub>ACO1</sub> + t <sub>AS</sub> ) <sup>[4, 22]</sup>	Com'l/Ind	45.4		34.4		27		MHz
	Mode $1/(t_{ACO1} + t_{AS})^{14, 22}$	Mil	45.4		34.4		27		
f <sub>MAXA2</sub>	Maximum Internal Asynchronous Frequency	Com'l/Ind	40		37		30.3		MHz
	1/(t <sub>ACF</sub> + t <sub>AS</sub> ) or 1/(t <sub>AWH</sub> + t <sub>AWL</sub> ) <sup>[4, 23]</sup>	Mil	40		37		30.3		
f <sub>MAXA3</sub>	Data Path Maximum Frequency in Asynchronous	Com'l/Ind	66.6		50		40		MHz
	Mode <sup>[4, 24]</sup>	Mil	66.6		50		40		
f <sub>MAXA4</sub>	Maximum Asynchronous Register Toggle Frequency 1/(t <sub>AWH</sub> + t <sub>AWL</sub> ) <sup>[4, 25]</sup>	Com'l/Ind	76.9		62.5		50		MHz
	Frequency 1/(t <sub>AWH</sub> + t <sub>AWL</sub> ) <sup>[4, 25]</sup>	Mil	76.9		62.5		50		
t <sub>AOH</sub>	Output Data Stable Time from Asynchronous Clock	Com'l/Ind	15		15		15		ns
	Input <sup>[4, 26]</sup>	Mil	15		15		15		

#### Notes:

- This specification is a measure of the delay from an asynchronous register clock input to internal feedback of the registered output signal to a combinatorial output for which the registered output signal is used as an input. Assumes no expanders are used in logic of combinatorial output or the asynchronous clock
- input. This parameter is tested periodically by sampling production material.
   This parameter is measured with a positive-edge-triggered clock at the register. For negative edge triggering, the t<sub>AWH</sub> and t<sub>AWL</sub> parameters must be swapped. If a given input is used to clock multiple registers with both positive and negative polarity, t<sub>AWH</sub> should be used for both t<sub>AWH</sub> and t<sub>AWL</sub>.
   This specification is a measure of the delay associated with the internal register feedback path for an asynchronously clocked register. This delay plus the asynchronous register set-up time, t<sub>AS</sub>, is the minimum internal period for an asynchronously clocked state machine configuration. This delay assumes no expander logic in the asynchronous clock path. This parameter is tested periodically by sampling production material.
- This parameter indicates the guaranteed maximum frequency at which an asynchronously clocked state machine configuration with external feedback can operate. It is assumed that no expander logic is employed in the clock signal path or data path.

  This specification indicates the guaranteed maximum frequency at which an asynchronously clocked state machine with internal-only feedback can operate. If register output states must also control external points, this frequency can still be observed as long as this frequency is less than 1/t<sub>ACO1</sub>. This specification assumes no expander logic is utilized. This parameter is tested periodically by sampling production material.
- 24. This specification indicates the guaranteed maximum frequency at which an individual output or buried register can be cycled in asynchronously clocked mode. This frequency is least of 1/(t<sub>AWH</sub> + t<sub>AWL</sub>), 1/(t<sub>AS</sub> + t<sub>AH</sub>), or 1/t<sub>ACO1</sub>. It also indicates the maximum frequency at which the device may operate in the asynchronously clocked data-path mode. Assumes no expander logic is used.
   25. This specification indicates the guaranteed maximum frequency at which an individual output or buried register can be cycled in asynchronously clocked
- mode by a clock signal applied to an external dedicated input or an I/O pin.

  This parameter indicates the minimum time that the previous register output data is maintained on the output pin after an asynchronous register clock input to an external dedicated input or I/O pin.



# Typical Internal Switching Characteristics Over Operating Range<sup>[7]</sup>

			7C3	44-15	7C3	44-20	7C3	44-25	
Parameter	Description		Min.	Max.	Min.	Max.	Min.	Max.	Unit
t <sub>IN</sub>	Dedicated Input Pad and Buffer Delay	Com'l/Ind		4		5		7	ns
		Mil		4		5		7	
t <sub>IO</sub>	I/O Input Pad and Buffer Delay	Com'l/Ind		4		5		7	ns
		Mil		4		5		7	
t <sub>EXP</sub>	Expander Array Delay	Com'l/Ind		8		10		15	ns
		Mil		8		10		15	
t <sub>LAD</sub>	Logic Array Data Delay	Com'l/Ind		7		9		10	ns
				7		9		10	
t <sub>LAC</sub>	Logic Array Control Delay	Com'l/Ind		5		7		7	ns
		Mil		5		7		7	
t <sub>OD</sub>	Output Buffer and Pad Delay	Com'l/Ind		4		5		5	ns
		Mil		4		5		5	
t <sub>ZX</sub>	Output Buffer Enable Delay <sup>[27]</sup>	Com'l/Ind		7		8		11	ns
		Mil		7		8		11	
t <sub>XZ</sub>	Output Buffer Disable Delay	Com'l/Ind		7		8		11	ns
		Mil		7		8		11	
t <sub>RSU</sub>	Register Set-Up Time Relative to Clock Signal	Com'l/Ind	5		5		8		ns
	at Register	Mil	5		5		8		
t <sub>RH</sub>	Register Hold Time Relative to Clock Signal at	Com'l/Ind	7		9		12		ns
Regist	Register	Mil	7		9		12		
t <sub>LATCH</sub> Flow-Through Latch [	Flow-Through Latch Delay	Com'l/Ind		1		1		3	ns
		Mil		1		1		3	
t <sub>RD</sub>	Register Delay	Com'l/Ind		1		1		1	ns
		Mil		1		1		1	
t <sub>COMB</sub>	Transparent Mode Delay <sup>[28]</sup>	Com'l/Ind		1		1		3	ns
		Mil		1		1		3	
t <sub>CH</sub>	Clock HIGH Time	Com'l/Ind	6		7		8		ns
		Mil	6		7		8		
t <sub>CL</sub>	Clock LOW Time	Com'l/Ind	6		7		8		ns
		Mil	6		7		8		
t <sub>IC</sub>	Asynchronous Clock Logic Delay	Com'l/Ind		7		8		10	ns
		Mil		7		8		10	
t <sub>ICS</sub>	Synchronous Clock Delay	Com'l/Ind		1		2		3	ns
		Mil		1		2		3	
t <sub>FD</sub>	Feedback Delay	Com'l/Ind		1		1		1	ns
		Mil		1		1		1	
t <sub>PRE</sub>	Asynchronous Register Preset Time	Com'l/Ind		5		6		9	ns
		Mil		5		6		9	
t <sub>CLR</sub>	Asynchronous Register Clear Time	Com'l/Ind		5		6		9	ns
		Mil		5		6		9	
t <sub>PCW</sub>	Asynchronous Preset and Clear Pulse Width	Com'l/Ind	5		5		7		ns
		Mil	5		5		7		



# Typical Internal Switching Characteristics Over Operating Range<sup>[7]</sup> (continued)

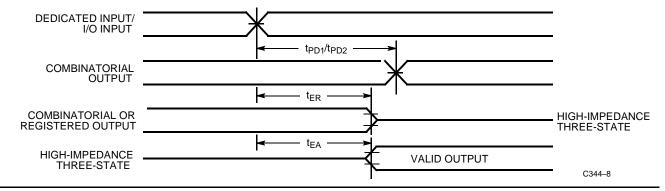
			7C34	44-15	7C3	44-20	7C34	14-25	
Parameter	Description		Min.	Max.	Min.	Max.	Min.	Max.	Unit
t <sub>PCR</sub>	Asynchronous Preset and Clear Recovery Time	Com'l/Ind	5		5		7		ns
		Mil	5		5		7		

<sup>27.</sup> Sample tested only for an output change of 500 mV.
28. This specification guarantees the maximum combinatorial delay associated with the macrocell register bypass when the macrocell is configured for combinatorial operation.

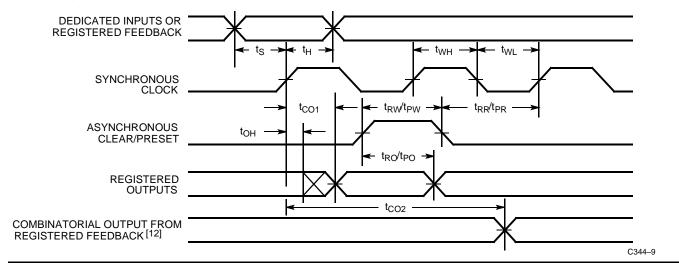


# **Switching Waveforms**

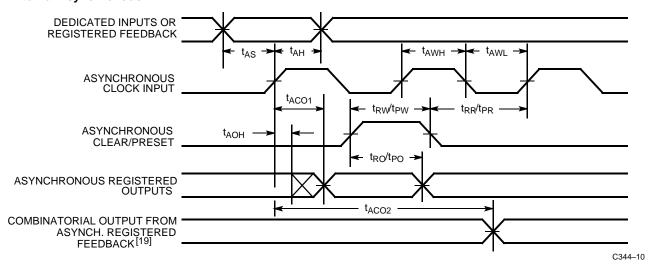
#### **External Combinatorial**



### **External Synchronous**



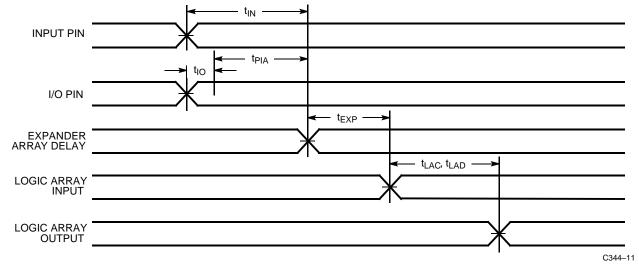
# **External Asynchronous**



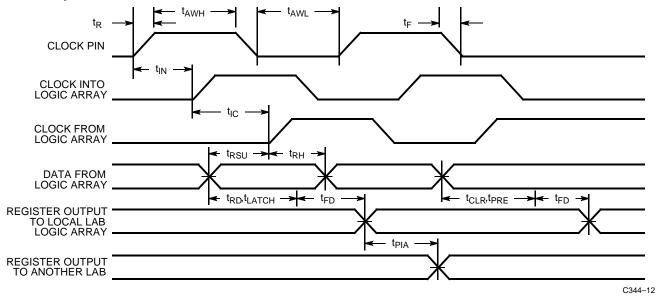


# Switching Waveforms (continued)

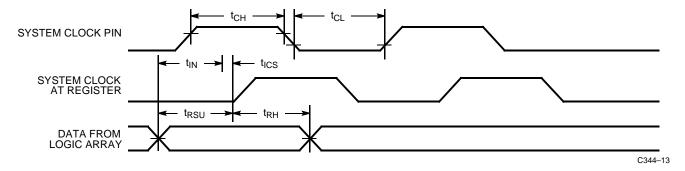
#### **Internal Combinatorial**



#### **Internal Asynchronous**



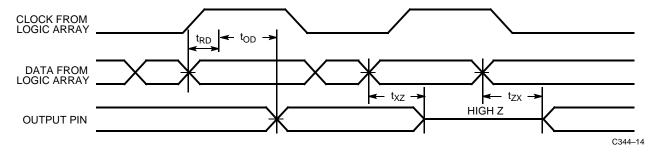
### **Internal Synchronous (Input Path)**





# Switching Waveforms (continued)

### **Internal Synchronous (Output Path)**



# **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
15	CY7C344-15HC/HI	H64	28-Lead Windowed Leaded Chip Carrier	Commercial/Industrial
	CY7C344-15JC/JI	J64	28-Lead Plastic Leaded Chip Carrier	
	CY7C344-15PC/PI	P21	28-Lead (300-Mil) Molded DIP	
	CY7C344-15WC/WI	W22	28-Lead Windowed CerDIP	
20	CY7C344-20HC/HI	H64	28-Lead Windowed Leaded Chip Carrier	Commercial/Industrial
	CY7C344-20JC/JI	J64	28-Lead Plastic Leaded Chip Carrier	
	CY7C344-20PC/PI	P21	28-Lead (300-Mil) Molded DIP	
	CY7C344-20WC/WI	W22	28-Lead Windowed CerDIP	
	CY7C344-20HMB	H64	28-Lead Windowed Leaded Chip Carrier	Military
	CY7C344-20WMB	W22	28-Lead Windowed CerDIP	
25	CY7C344-25HC/HI	H64	28-Lead Windowed Leaded Chip Carrier	Commercial/Industrial
	CY7C344-25JC/JI	J64	28-Lead Plastic Leaded Chip Carrier	
	CY7C344-25PC/PI	P21	28-Lead (300-Mil) Molded DIP	
	CY7C344-25WC/WI	W22	28-Lead Windowed CerDIP	
	CY7C344-25HMB	H64	28-Lead Windowed Leaded Chip Carrier	Military
	CY7C344-25WMB	W22	28-Lead Windowed CerDIP	

# MILITARY SPECIFICATIONS Group A Subgroup Testing

### **DC Characteristics**

Parameter	Subgroups
V <sub>OH</sub>	1, 2, 3
V <sub>OL</sub>	1, 2, 3
V <sub>IH</sub>	1, 2, 3
V <sub>IL</sub>	1, 2, 3
I <sub>IX</sub>	1, 2, 3
I <sub>OZ</sub>	1, 2, 3
I <sub>CC1</sub>	1, 2, 3

# **Switching Characteristics**

Parameter	Subgroups
t <sub>PD1</sub>	7, 8, 9, 10, 11
t <sub>PD2</sub>	7, 8, 9, 10, 11
t <sub>PD3</sub>	7, 8, 9, 10, 11
t <sub>CO1</sub>	7, 8, 9, 10, 11
t <sub>S</sub>	7, 8, 9, 10, 11
t <sub>H</sub>	7, 8, 9, 10, 11
t <sub>ACO1</sub>	7, 8, 9, 10, 11
t <sub>ACO1</sub>	7, 8, 9, 10, 11
t <sub>AS</sub>	7, 8, 9, 10, 11
t <sub>AH</sub>	7, 8, 9, 10, 11

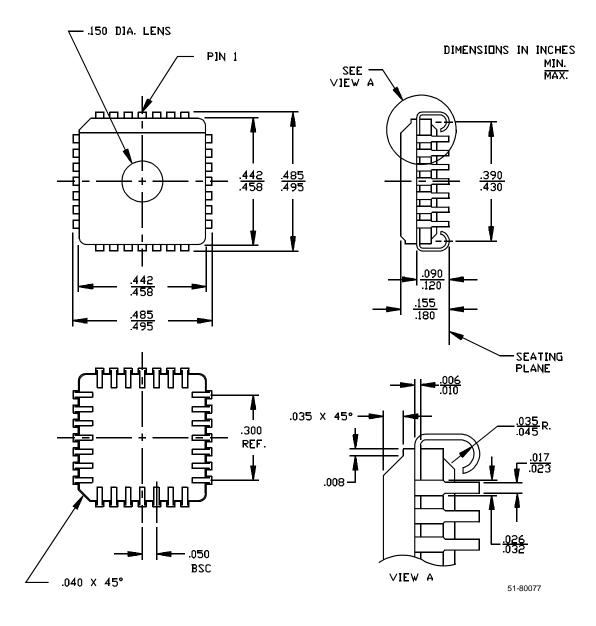
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Warp, Warp Professional, and Warp Enterprise are trademarks of Cypress Semiconductor.



# **Package Diagrams**

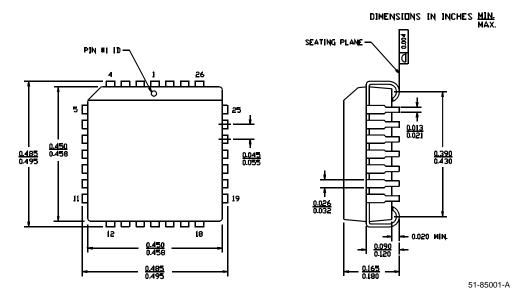
# 28-Pin Windowed Leaded Chip Carrier H64



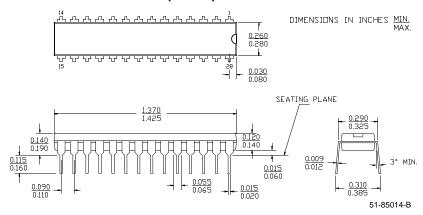


# Package Diagrams (continued)

# 28-Lead Plastic Leaded Chip Carrier J64



# 28-Lead (300-Mil) Molded DIP P21

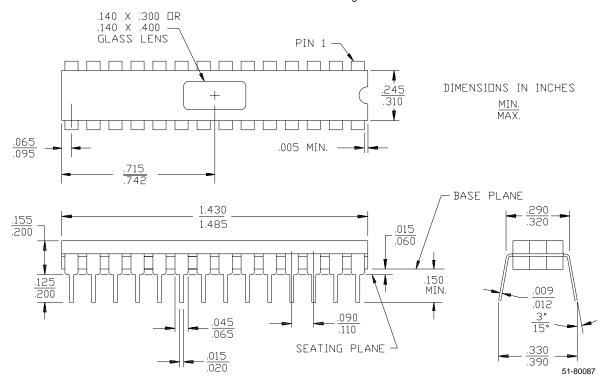




# Package Diagrams (continued)

### 28-Lead (300-Mil) Windowed CerDIP W22

MIL-STD-1835 D-15 Config. A





Document Title: CY7C344 32-Macrocell MAX® EPLD Document Number: 38-03006				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	106271	04/19/01	SZV	Change from Spec number: 38-00127 to 38-03006